

# KY8030 *NOVA*

## The Best Value 3D Solder Pasted Inspection Solution

Delivering an ideal mix of cost and performance, the KY8030 Nova provides the best value for a varied set of application needs demanding enhanced product quality, increased productivity, and improved operational efficiency.

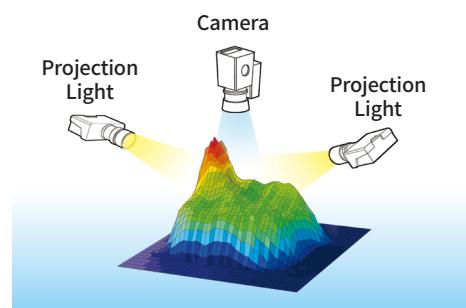


# KY8030 NOVA



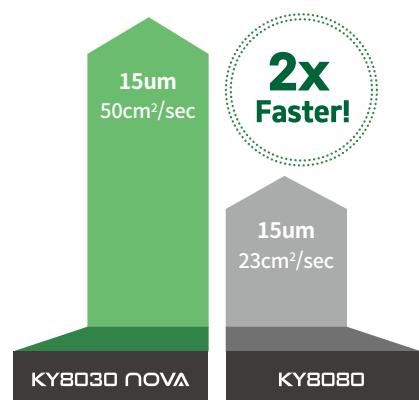
## Best-in-class Measurement Accuracy and Inspection Reliability

- Koh Young's inspection systems have become the industry standard. The KY8030 Nova features a pioneering True 3D Moiré by eliminating shadow and specular reflection challenges without compromising accuracy.



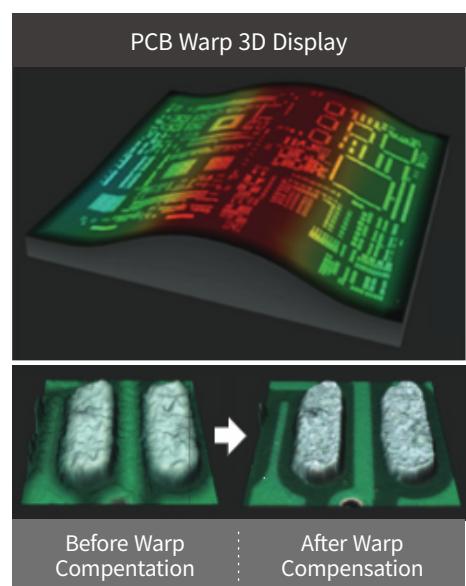
## Unmatched Inspection Speed with Guaranteed Best Accuracy

- The KY8030 Nova blends Koh Young's pioneering technologies with an inspection speed of  $50\text{cm}^2/\text{sec}$ . The combination of this system's throughput and accuracy makes the KY8030 Nova suitable across a vast range of applications. The latest options makes this system twice as fast as our KY8080 with guaranteed measurement accuracy.



## Robust Real-time Active Warp Compensation

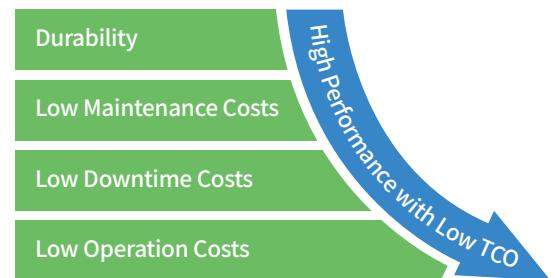
- Achieve unparalleled accuracy with KY's real-time automatic referencing technology. Using advanced 3D imaging and algorithms, it accounts for factors such as tilt, stretch, twist, bow and shrinkage. This system dynamically adapts to non-linear inspection challenges using automatic reference teaching. It compares PCB pad locations to the ideal stencil design from the CAD file. You can rely on precise compensation for optimal inspection performance every time.



## Merging Value with Performance



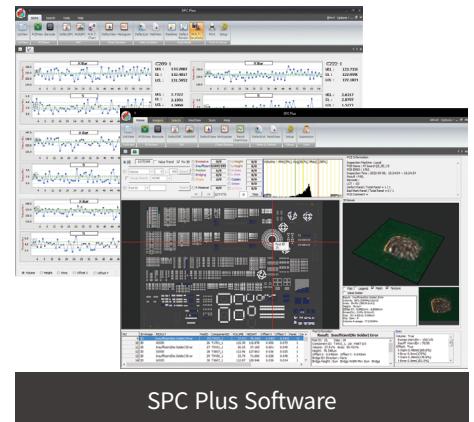
- Combining Koh Young's Optomechatronics expertise with advanced vision algorithms and leading inspection technologies, the KY8030 Nova delivers high performance while keeping costs low, reducing the total cost of ownership (TCO).



## SPC-based Process Improvements



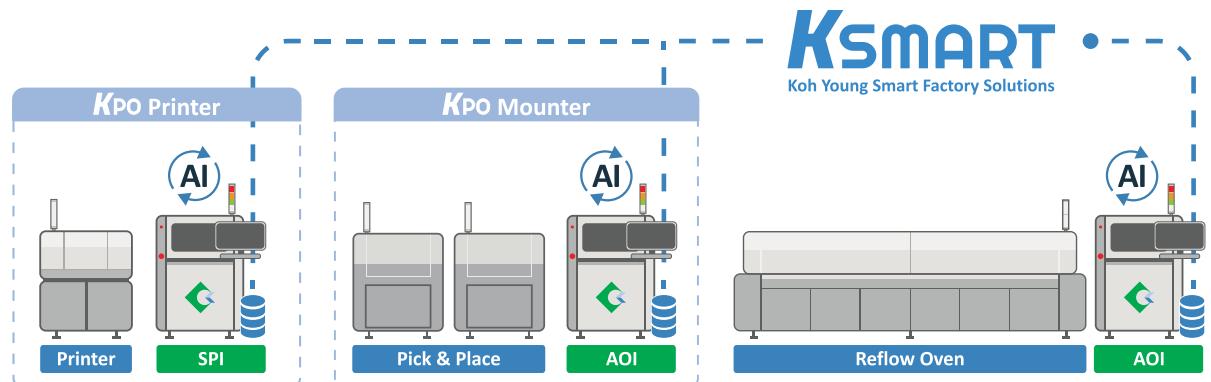
- Koh Young provides a state-of-the-art SPC toolkit used widely throughout the industry. The comprehensive SPC Plus allows users to easily understand their production process with the following features: histograms, X-bar & R-chart, X-bar & S-chart, Cp & CpK, % of Gage R&R. Data can be viewed in real-time and in a multiple display format. The software even generates automatic reports from a remote computer. The KY8030 Nova allows customers to improve their production quality while reducing operating costs to increase manufacturing visibility.



## The Gateway to a Smart Factory



- Maximizing production efficiency by combining industry standards with AI engines to go beyond simple machine connectivity and open the gates to a smart factory to everyone.



# Must-Check Requirements of a 3D SPI System

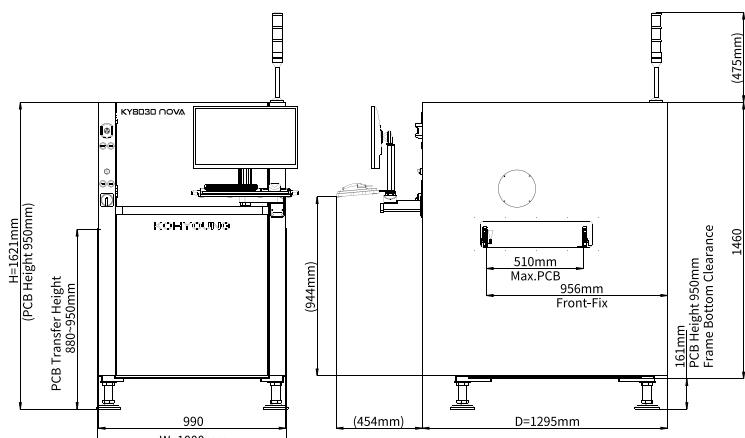
Requirements			Solutions					
Solution to shadow problem			3D shadow free moiré technology & dual projection					
Real-time PCB warp compensation (2D + 3D solution)			Active warp compensation (Z-tracking & pad-referencing)					
User-friendly operation			Renewal GUI, real color 3D image					
Whole-board Foreign Material Inspection (WFMI)			3D foreign material inspection (Optional)					
Inspection Task	Metrology Capability	Volume, area, height, offset, bridging, shape deformity, paste offset, coplanarity	Type of Defects	Insufficient, excessive, missing paste, bridging, shape deformity, paste offset, coplanarity				
Inspection Performance	Model	Camera	Pixel Resolution	Full Speed Inspection Speed	Min. Distance between Pads	Max. Inspection Height		
	KY8030 Nova	9 Mpix	15 µm	50 cm <sup>2</sup> /sec (0.35 sec/FOV)	150 µm	600 µm~1 mm (23.6 mils~39.3 mils)		
			10 µm	25 cm <sup>2</sup> /sec (0.31 sec/FOV)	100 µm			
	Illumination		IR-RGB LED Dome Styled Illumination (Optional)					
	Z-Resolution		0.37 µm / 0.01 mils					
	Height Accuracy (on KY calibration target)		1 µm / 0.04 mils					
	0201mm Inspection Capability		Gage R&R < 10 % at 6 Sigma (± 50 % Tolerance)					
Software	Max. Inspection Size		< FOV					
	Multi-Colored PCB Inspection		Possible					
Add-On Solutions	Supported Input Format		GERBER Data (274X, 274D), ODB++ (Optional)					
	Programming Software		ePM-SPI (Optional)					
	Statistical Process Control Tool		SPC Plus (Histogram, X-bar & R-Chart, X-bar & S-Chart, Cp & Cpk, % Gage R&R / Real Time SPC & Multiple Display / SPC Alarm / Automatic Report from Remote Computer)					
	User-Friendly Features		Library Manager (Optional), KYCAL (Auto Camera Calibration, Auto Illumination Calibration, Auto Height Calibration)					
	Operating System		WINDOWS 10 IoT ENTERPRISE LTSC 2019					

The above specifications are subject to change without prior notice.

PCB Handling & Installation Requirements		
Conveyor	Width Adjustment	Automatic
	Fix type	Front / Rear fixed (Factory setting)
Type	L	
	Single Lane	Dual Lane
Max. PCB Size (X x Y)	490 x 510 mm (19.2 x 20.0 in)	Single mode 490 x 580 mm (19.2 x 22.8 in)
		Dual mode 490 x 320 mm (19.2 x 12.5 in)
Min. PCB Size	50 x 50 mm (1.9 x 1.9 in)	
PCB Thickness	0.4 ~ 4.0 mm (0.01 ~ 0.15 in)	
Max. PCB Weight	3 kg (6.6 lbs)	
Machine Weight	600 kg (1322.7 lbs)	700 kg (1543.2 lbs)
Clearance	Top	50 mm (1.96 in)
	Bottom	50 mm (1.96 in)
Electrical Supply	220VAC, 1Phase, 50/60Hz	
W	1,000 mm (39.3 in)	
D	1,295 mm (50.9 in)	1,475 mm (58.1 in)
H	1,621 mm (63.8 in)	

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\* Please contact us for more information about PCB Sizes.



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